XP151A12A2MR

Power MOSFET

■GENERAL DESCRIPTION

The XP151A12A2MR is an N-channel Power MOSFET with low on state resistance and ultra high-speed switching characteristics. Because high-speed switching is possible, the IC can be efficiently set thereby saving energy. In order to counter static, a gate protect diode is built-in.

The small SOT-23 package makes high density mounting possible.

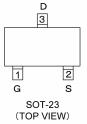
■APPLICATIONS

- Notebook PCs
- Cellular and portable phones
- On-board power supplies
- Li-ion battery systems

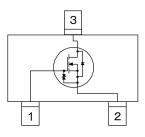
FEATURES

Low On-State Resistance : Rds(on) = 0.1Ω@ Vgs = 4.5V : Rds(on) = 0.16 Ω @ Vgs = 2.5V **Ultra High-Speed Switching** Gate Protect Diode Built-in **Driving Voltage** : 2.5V **N-Channel Power MOSFET DMOS Structure** Small Package : SOT-23

■PIN CONFIGURATION



■EQUIVALENT CIRCUIT



N-channel MOSFET (1 device built-in)

■PIN ASSIGNMENT

PIN NUMBER	PIN NAME	FUNCTION
1	G	Gate
2	S	Source
3	D	Drain

■ABSOLUTE MAXIMUM RATINGS

		Та	= 25°C
PARAMETER	SYMBOL	RATINGS	UNITS
Drain - Source Voltage	Vdss	20	V
Gate - Source Voltage	Vgss	±12	V
Drain Current (DC)	ld	1	А
Drain Current (Pulse)	ldp	4	А
Reverse Drain Current	ldr	1	А
Channel Power Dissipation *	Pd	0.5	W
Channel Temperature	Tch	150	°C
Storage Temperature Range	Tstg	-55~150	°C

* When implemented on a ceramic PCB

■ELECTRICAL CHARACTERISTICS

DC Characteristics

DC Characteristics					Т	a = 25°C
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Drain Cut-Off Current	ldss	Vds= 20V, Vgs= 0V	-	-	10	μA
Gate-Source Leak Current	lgss	Vgs= \pm 12V, Vds= 0V	-	-	±10	μA
Gate-Source Cut-Off Voltage	Vgs(off)	Id= 1mA, Vds= 10V	0.7	-	1.4	V
Drain-Source On-State Resistance *1	Rds(on)	ld= 0.5A, Vgs= 4.5V	-	0.075	0.1	Ω
	Rus(UII)	ld= 0.5A, Vgs= 2.5V	-	0.120	0.160	Ω
Forward Transfer Admittance *1	Yfs	ld= 0.5A, Vds= 10V	-	3.3	-	S
Body Drain Diode Forward Voltage	Vf	lf= 1A, Vgs= 0V	-	0.8	1.1	V

*1 Effective during pulse test.

Dynamic Characteristics

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PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Input Capacitance	Ciss		-	180	-	pF
Output Capacitance	Coss	Vds= 10V, Vgs=0V f= 1MHz	-	120	-	pF
Feedback Capacitance	Crss	1- 11/11/2	-	45	-	pF

Switching Characteristics

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-On Delay Time	td (on)	Vgs= 5V, Id= 0.5A Vdd= 10V	-	10	-	ns
Rise Time	tr		-	15	-	ns
Turn-Off Delay Time	td (off)		-	50	-	ns
Fall Time	tf		-	45	-	ns

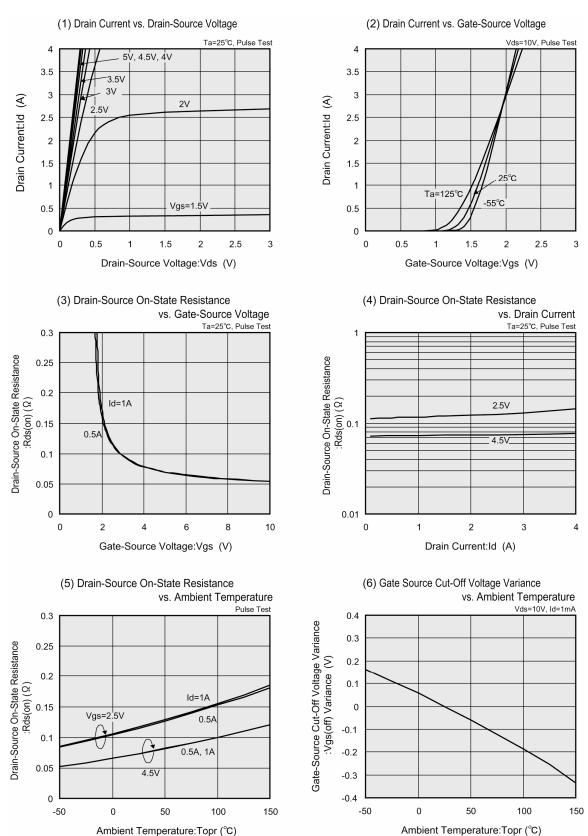
Thermal Characteristics

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Thermal Resistance (Channel-Ambience)	Rth (ch-a)	Implement on a ceramic PCB	-	250	-	°C/W

Ta = 25°C

Ta = 25°C

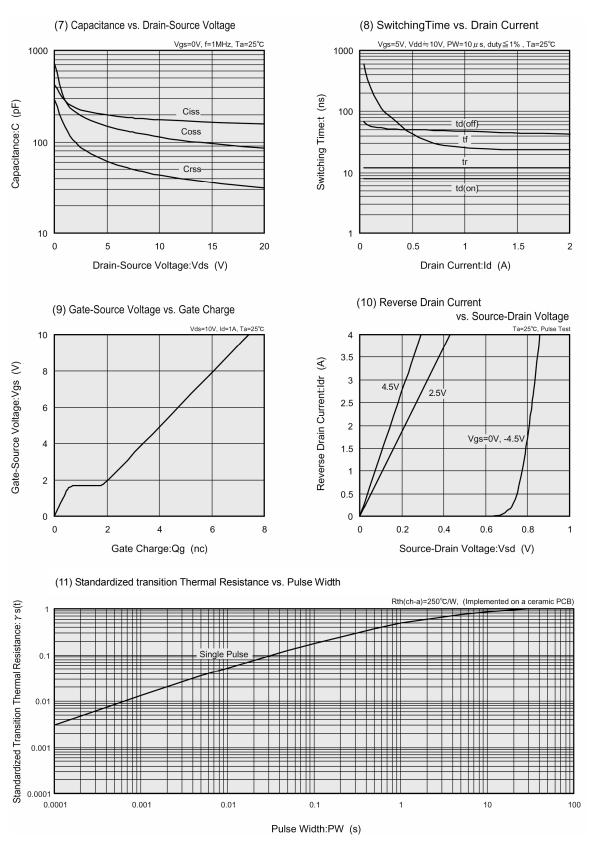
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■TYPICAL PERFOMANCE CHARACTERISTICS

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■TYPICAL PERFOMANCE CHARACTERISTICS (Continued)



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